



Material Content Data Sheet



Sales Product Name		BAR 64-02EL E6327		Issued		19. July 2018		
MA#		MA001115932						
Package		PG-TSLP-2-19		Weight*		0.61 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	tin	7440-31-5	0.001	0.10		1015	
	noble metal	gold	7440-57-5	0.002	0.39		3939	
	inorganic material	silicon	7440-21-3	0.029	4.81	5.30	48066	53020
leadframe	non noble metal	nickel	7440-02-0	0.241	39.39	39.39	393866	393866
wire	non noble metal	copper	7440-50-8	0.003	0.41	0.41	4100	4100
encapsulation	organic material	carbon black	1333-86-4	0.002	0.25		2548	
	plastics	epoxy resin	-	0.045	7.39		73891	
	inorganic material	silicondioxide	60676-86-0	0.265	43.31	50.95	433160	509599
leadfinish	noble metal	gold	7440-57-5	0.010	1.71	1.71	17055	17055
plating	noble metal	palladium	7440-05-3	0.003	0.53		5305	
	noble metal	gold	7440-57-5	0.010	1.71	2.24	17055	22360
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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